## **Product/Process Change Notifications**

## **Amphenol ICC**

PCN - 21 104 R1

Amphenol Information Communication and Commercial Products Group

www.amphenol-icc.com				Release Date:	August	24	2021	
Product Name:	HPL - 670/671							
	PCIE Gen4 & Gen5 SMT series							
Product Manager:	Bonnie Liu							
Subject:	Notification of Change with Immediate Effectivity							
Distribution:	Affected customers							
Type of Change:	Design Change							
Change Description:	Change design of the structure to make the side latch more rubust during reflow.  * Adding the supporting feature (located behind the latch arm), will prevent over-flexing or breaking of latch while unlatching Add-in-card (AIC).  **Control of the structure to make the side latch more rubust during reflow.							
Reason for Change:	The original latch is weak after high tempresure reflow.							
Affected Parts:	Base PN: 10	0155214 / 101593	09 / 10161112 / 10164121	1 / 10150775				
Effective Date of Change:	7 October, 2021							
Last Time Buy Date:	10 November ,2021		Note: PCN21104R1 is a rev.	Note: PCN21104R1 is a revision of PCN21104 dtd Aug 24, 2021. Changes apply to				
Earliest Disty Return Date:			Affected parts list and Effect	ive date.				
Last Time Shipment Date								
Datasheet Attached?	Yes							
Qual/Test Data Attached?	Yes							
Samples Availability Date:	31 August ,2021							
Available Alternatives?								
Questions?	Contact your local AICC Representative, or Product Manager							
	Bonnie Liu / Product Manager							
	Bonnie.liu @fci.com							
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## Note

Customers should contact Product Manager (or their local AICC Representative) directly regarding any concern on the PCN. Lack of any such customer feedback within three weeks of PCN release date will be interpreted as non-objection.